

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Tzung-Han TAN</td> <td>07/15/2013</td> </tr> <tr> <td>Bang-Chiang Lan</td> <td>07/15/2013</td> </tr> <tr> <td>Ming-I Wang</td> <td>06/18/2013</td> </tr> <tr> <td>Chien-Hsin HUANG</td> <td>07/15/2013</td> </tr> <tr> <td>Meng-Jia LIN</td> <td>07/15/2013</td> </tr> </tbody> </table>		Name	Execution Date	Tzung-Han TAN	07/15/2013	Bang-Chiang Lan	07/15/2013	Ming-I Wang	06/18/2013	Chien-Hsin HUANG	07/15/2013	Meng-Jia LIN	07/15/2013
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Meng-Jia LIN	07/15/2013												
RECEIVING PARTY DATA													
Name:	UNITED MICROELECTRONICS CORPORATION												
Street Address:	NO. 3, LI-HSIN RD. II												
Internal Address:	SCIENCE-BASED INDUSTRIAL PARK												
City:	HSINCHU												
State/Country:	TAIWAN												
PROPERTY NUMBERS Total: 1													
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>13945892</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	13945892								
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Application Number:	13945892												
CORRESPONDENCE DATA													
Fax Number:	5306859794												
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>													
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NAME OF SUBMITTER:	Ding Yu Tan												
Signature:	/Ding Yu Tan/												

OP \$40.00 13945892

Date:	07/18/2013
	This document serves as an Oath/Declaration (37 CFR 1.63).
<p>Total Attachments: 4 source=09061UMC_USP1D1_DA#page1.tif source=09061UMC_USP1D1_DA#page2.tif source=09061UMC_USP1D1_DA#page3.tif source=09061UMC_USP1D1_DA#page4.tif</p>	

**Declaration (37 CFR 1.63) for Utility Patent Application Using An
Application Data Sheet (37 CFR 1.76) and
Assignment For Single Assignee**

The title of the invention is as follow:

METHOD FOR FABRICATING MEMS DEVICE WITH PROTECTION RINGS

As a below named inventor, I hereby declare that this declaration is directed to the application of which is attached hereto unless the following box is checked:

was filed on _____ as United States Application Number or PCT International Application Number _____

The above-identified application was made or authorized to be made by me.

I believe I am the original inventor or an original joint inventor of a claimed invention in the application.

WHEREAS, United Microelectronics Corporation (hereinafter referred to "Assignee") whose mailing address is NO. 3, LI-HSIN RD. II, SCIENCE-BASED INDUSTRIAL PARK, HSINCHU, TAIWAN is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent that may be granted therefore in the United States and its territorial possessions and in any and all foreign countries;

Now, therefore, in consideration of the sum of One dollars (\$ 1.00), the receipt whereof is acknowledged, and for other good and valuable consideration, I, by these presents hereby do sell, assign and transfer unto said Assignee the entire right, title, and interest in and to any and all improvements which are disclosed in said invention and, in and to, all Letters Patent which may be granted therefor in the United States and its territorial possessions and in any and all foreign countries and in and to any and all continuations, continuation-in-part, divisions, renewals, substitutions, or extensions thereof, and as to Letters Patent any reissue or re-examination thereof.

I hereby authorize and request the Patent Office Officials in the United States and its territorial possessions and any and all foreign countries to issue any and all of said Letters Patent, when granted, to said Assignee as the assignee of my entire right, title and interest in and to the same, for the sole use and behoof of said Assignee, its (his) successors and assigns, to the full end of the term for which said Letters Patent may be granted, as fully and entirely as the same would have been held by me had this Assignment and sale not been made.

Further, I agree that I will communicate to said Assignee or its (his) representatives any facts known to me respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute, renewal and reissue applications, execute all necessary assignment papers to cause any and all of said Letters Patent to be issued to said Assignee, make all rightful oaths, and, generally do everything possible to aid said Assignee, its (his) successors and assigns, to obtain and enforce proper protection for said invention in the United States and its territorial possessions and in any and all foreign countries.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

Direct all Correspondence to:

The Address Associated with Customer Number 66749

Legal Name of Additional Joint Inventor, if any:	
Inventor's signature	Date

Legal Name of Additional Joint Inventor, if any:	
Inventor's signature	Date

Legal Name of Additional Joint Inventor, if any: Ming-I WANG	
Inventor's signature <i>Ming-I Wang</i>	Date 2013-6-18

Legal Name of Additional Joint Inventor, if any:	
Inventor's signature	Date

Legal Name of Additional Joint Inventor, if any:	
Inventor's signature	Date

Additional inventors are being named on the next page, if any

Legal Name of Additional Joint Inventor, if any: Tzung-Han TAN	
Inventor's signature <i>Tzung Han Tan</i>	Date JUL 15 2013

Legal Name of Additional Joint Inventor, if any: Bang-Chiang LAN	
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Legal Name of Additional Joint Inventor, if any:	
Inventor's signature	Date

Legal Name of Additional Joint Inventor, if any: Chien-Hsin HUANG	
Inventor's signature <i>Chien-Hsin Huang</i>	Date JUL 15 2013 JUL 15 2013

Legal Name of Additional Joint Inventor, if any: Meng-Jia LIN	
Inventor's signature <i>Meng Jia Lin</i>	Date JUL 15 2013

Additional inventors are being named on the next page, if any